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MBRB10200CT

10A SCHOTTKY BARRIER RECTIFIER

Product Summary

MBRB10200CT	(Per Leg)
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V _{RRM} (V)	I _O (A)	V _{F (MAX)} (V) @ +25°C	I _{R (MAX)} (mA) @ +25°C
200	5	0.91	0.1

Description and Applications

This Schottky Barrier Rectifier is designed to meet the general requirements of Commercial Applications. It is ideally suited for use as:

- Polarity Protection Diode
- Re-Circulating Diode
- Switching Diode



TO263AB (D2PAK)

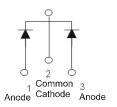
Top View

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- High Surge Current Capability
- Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TO263AB (D2PAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208[®]
- · Polarity: See Below
- Weight: TO263AB (D2PAK) 1.6 grams (Approximate)



Package Pin Out

Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
MBRB10200CT	TO263AB (D2PAK)	50 pieces/Tube
MBRB10200CT-13	TO263AB (D2PAK)	800 pieces/Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



MBRB10200CT = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 14 = 2014) WW = Week (01 - 53)



Maximum Ratings (Per Leg) (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	200	٧
Average Rectified Output Current (Per Leg) (Total)	Io	5 10	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	110	A

Thermal Characteristics (Per Leg)

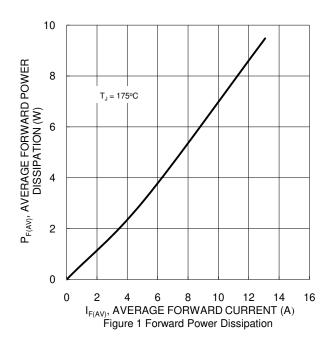
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	R _{eJC}	5	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 5)	R _{eJA}	20	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +175	°C

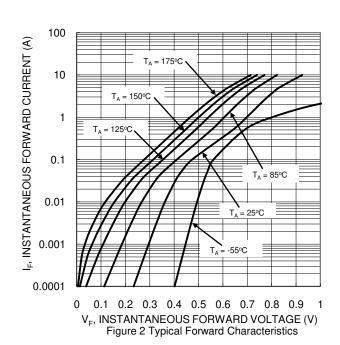
Electrical Characteristics (Per Leg) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop V _F	_	0.85	0.91		I _F = 5A, T _J = +25°C	
	• •	_	_	0.84		$I_F = 5A, T_J = +125$ °C
Leakage Current (Note 6)	l-	_	_	0.1	mA	$V_R = 200V, T_J = +25$ °C
Leakage Guiterit (Note 6)	IR	_	_	10	ША	$V_R = 200V, T_J = +125$ °C

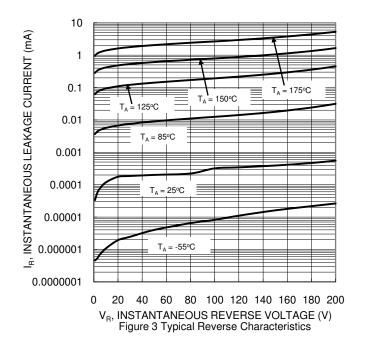
Notes:

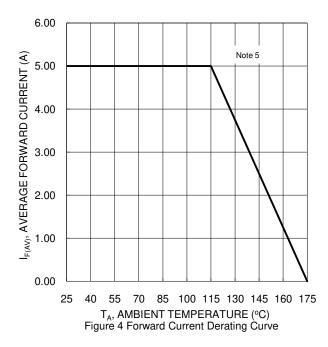
- 5. Test with 2 inch Al board.
- 6. Short duration pulse test used to minimize self-heating effect.







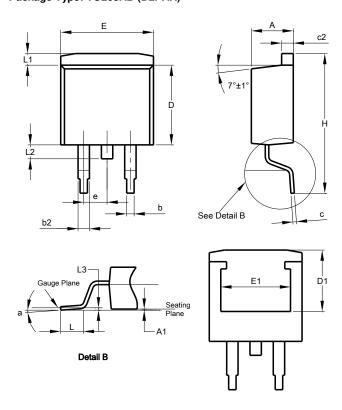




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

(1) Package Type: TO263AB (D2PAK)



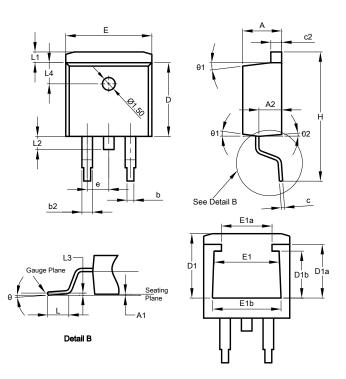
TO263AB (D2PAK)				
Dim	Min	Max	Тур	
Α	4.07	4.82	-	
A 1	0.00	0.25	-	
b	0.51	0.99	-	
b2	1.15	1.77	-	
С	0.356	0.73	-	
c2	1.143	1.65	-	
D	8.39	9.65	-	
D1	6.55	-	-	
е	2.54 TYP			
E	9.66 10.66 -			
E1	6.23	-	-	
Н	14.61	15.87	-	
L	1.78	2.79	-	
L1	-	1.67	-	
L2	-	1.77	-	
а	0°	8°	-	
All Dimensions in mm				



Package Outline Dimensions (cont.)

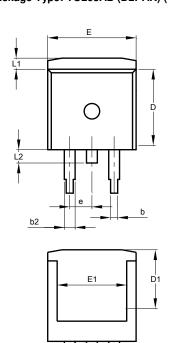
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

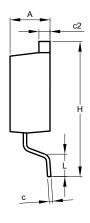
(2) Package Type: TO263AB (D2PAK) (Type B)



TO	TO263AB (D2PAK)				
	(Туре				
Dim		Min Max Typ			
Α	4.40	4.70	4.57		
A 1	0.00	0.20	0.10		
A2	2.59	2.79	2.69		
b	0.77	0.90	0.813		
b2	1.20	1.36	1.27		
C	0.356	0.47	0.381		
c2	1.22	1.32	1.27		
D	8.60	8.80	8.70		
D1	6.60	7.80	7.60		
D1a	5.33 6.53 6.3		6.33		
D1b	4.54 5.74 5.54				
е	2.54 BSC				
Е			10.10		
E1	6.67	7.87	7.67		
E1a	4.94	6.14	5.94		
E1b	7.06	8.26	8.06		
Н	14.70	15.50	15.10		
L L1	2.00	2.60	2.30		
L1	1.17	1.40	1.27		
L2	1.45	1.70	1.55		
L3	0.25 BSC				
L4	2.50 REF				
θ	0°	8°	5°		
θ1	5°	9°	7°		
θ2	1° 5° 3°				
All Dimensions in mm					

(3) Package Type: TO263AB (D2PAK) (Type C)



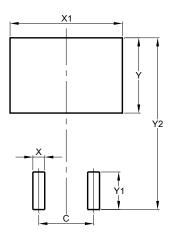


TO263AB (D2PAK) Type C					
Dim					
Α	4.30	4.70	-		
b	0.70	0.90	-		
b2	1.15	1.35	-		
С	0.40	0.60	-		
c2	1.20	1.40	-		
D	9.00	9.40	-		
D1	7.96	8.36	-		
Е	9.80	10.20	-		
E1	7.85	8.05	-		
е	2.34	2.74			
Н	15.00	15.87	-		
L	2.24	2.84	-		
L1	1.00	1.40	-		
L2	1.20	1.60	-		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
С	5.08
X	1.10
X1	10.41
Υ	3.50
Y1	7.01
Y2	15.99



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